September 1998

National Semiconductor

LM2674 SIMPLE SWITCHER[®] Power Converter High Efficiency 500 mA Step-Down Voltage Regulator

General Description

The LM2674 series of regulators are monolithic integrated circuits built with a LMDMOS process. These regulators provide all the active functions for a step-down (buck) switching regulator, capable of driving a 500 mA load current with excellent line and load regulation. These devices are available in fixed output voltages of 3.3V, 5.0V, 12V, and an adjustable output version.

Requiring a minimum number of external components, these regulators are simple to use and include patented internal frequency compensation (Patent Nos. 5,382,918 and 5,514,947) and a fixed frequency oscillator.

The LM2674 series operates at a switching frequency of 260 kHz, thus allowing smaller sized filter components than what would be needed with lower frequency switching regulators. Because of its very high efficiency (>90%), the copper traces on the printed circuit board are the only heat sinking needed.

A family of standard inductors for use with the LM2674 are available from several different manufacturers. This feature greatly simplifies the design of switch-mode power supplies using these advanced ICs. Also included in the datasheet are selector guides for diodes and capacitors designed to work in switch-mode power supplies.

Other features include a guaranteed ±1.5% tolerance on output voltage within specified input voltages and output load conditions, and ±10% on the oscillator frequency. External shutdown is included, featuring typically 50 μA stand-by current. The output switch includes current limiting, as well as thermal shutdown for full protection under fault conditions.

'IN **O--**to 40V

100 //

Typical Application

To simplify the LM2674 buck regulator design procedure, there exists computer design software, LM267X Made Simple.

Features

- Efficiency up to 96%
- Available in SO-8 and 8-pin DIP packages
- Computer Design Software LM267X Made Simple
- Simple and easy to design with
- Requires only 5 external components
- Uses readily available standard inductors
- 3.3V, 5.0V, 12V, and adjustable output versions
- Adjustable version output voltage range: 1.21V to 37V
 - ±1.5% max output voltage tolerance over line and load conditions
- Guaranteed 500mA output load current
- 0.25Ω DMOS Output Switch
- Wide input voltage range: 8V to 40V
- 260 kHz fixed frequency internal oscillator
- TTL shutdown capability, low power standby mode
- Thermal shutdown and current limit protection

Typical Applications

- Simple High Efficiency (>90%) Step-Down (Buck) Regulator
- Positive-to-Negative Converter

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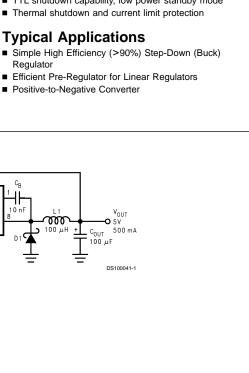
100 µH

CB

LM2674-5.0

GND

ON/OFF



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	45V
ON/OFF Pin Voltage	$-0.1V \le V_{SH} \le 6V$
Switch Voltage to Ground	-1V
Boost Pin Voltage	V _{SW} + 8V
Feedback Pin Voltage	$-0.3V \le V_{FB} \le 14V$
ESD Susceptibility	
Human Body Model (Note 2)	2 kV
Power Dissipation	Internally Limited

Storage Temperature Range	-65°C to +150°C
Lead Temperature	
M Package	
Vapor Phase (60s)	+215°C
Infrared (15s)	+220°C
N Package (Soldering, 10s)	+260°C
Maximum Junction Temperature	+150°C

Operating Ratings

Supply Voltage	6.5V to 40V
Junction Temperature Range	$-40^{\circ}C \le T_{J} \le +125^{\circ}C$

Electrical Characteristics Specifications with standard type face are for $T_J = 25$ °C, and those with **bold** type face apply over full Operating Temperature Range.

LM2674-3.3

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Symbol	Parameter	Conditions	Typical	Min	Max	Units
			(Note 4)	(Note 5)	(Note 5)	
SYSTEM PARAMETERS Test Circuit Figure 2 (Note 3)						
V _{OUT}	Output Voltage	V_{IN} = 8V to 40V, I_{LOAD} = 20 mA to 500 mA	3.3	3.251/ 3.201	3.350/ 3.399	V
Vout	Output Voltage	V_{IN} = 6.5V to 40V, I_{LOAD} = 20 mA to 250 mA	3.3	3.251/ 3.201	3.350/ 3.399	V
η	Efficiency	V _{IN} = 12V, I _{LOAD} = 500 mA	86			%

LM2674-5.0

Symbol	Parameter	Conditions	Typical	Min	Max	Units
			(Note 4)	(Note 5)	(Note 5)	
SYSTEM PARAMETERS Test Circuit Figure 2 (Note 3)						
V _{OUT}	Output Voltage	V_{IN} = 8V to 40V, I_{LOAD} = 20 mA to 500 mA	5.0	4.925/ 4.850	5.075/ 5.150	V
V _{OUT}	Output Voltage	V_{IN} = 6.5V to 40V, I_{LOAD} = 20 mA to 250 mA	5.0	4.925/ 4.850	5.075/ 5.150	V
η	Efficiency	V _{IN} = 12V, I _{LOAD} = 500 mA	90			%

LM2674-12

Symbol	Parameter Conditions		Typical	Min	Max	Units	
			(Note 4)	(Note 5)	(Note 5)		
SYSTEM	SYSTEM PARAMETERS Test Circuit Figure 2 (Note 3)						
V _{OUT}	Output Voltage	V_{IN} = 15V to 40V, I_{LOAD} = 20 mA to 500 mA	12	11.82/ 11.64	12.18/ 12.36	V	
η	Efficiency	V _{IN} = 24V, I _{LOAD} = 500 mA	94			%	

LM2674-ADJ

Symbol	Parameter	Conditions	Тур	Min	Max	Units
			(Note 4)	(Note 5)	(Note 5)	
SYSTEM	I PARAMETERS T	est Circuit Figure 3 (Note 3)				
V _{FB}	Feedback Voltage	V_{IN} = 8V to 40V, I _{LOAD} = 20 mA to 500 mA V _{OUT} Programmed for 5V (see Circuit of <i>Figure 3</i>)	1.210	1.192/ 1.174	1.228/ 1.246	v
V _{FB} Feedback V _{IN} = 6.5V to 40V, I _{LOAD} = 20 mA to 250 mA Voltage V _{OUT} Programmed for 5V (see Circuit of <i>Figure 3</i>)		1.210	1.192/ 1.174	1.228/ 1.246	v	
η	Efficiency	$V_{IN} = 12V, I_{LOAD} = 500 \text{ mA}$	90			%

All Output Voltage Versions

Electrical Characteristics

Specifications with standard type face are for $T_J = 25$ °C, and those with **bold type face** apply over **full Operating Temperature Range**. Unless otherwise specified, $V_{IN} = 12V$ for the 3.3V, 5V, and Adjustable versions and $V_{IN} = 24V$ for the 12V version, and $I_{LOAD} = 100$ mA.

Symbol	Parameters	Conditions	Тур	Min	Max	Units
DEVICE I	PARAMETERS		•			
I _Q Quiescent Current		V _{FEEDBACK} = 8V For 3.3V, 5.0V, and ADJ Versions	2.5		3.6	mA
		V _{FEEDBACK} = 15V For 12V Versions	2.5			mA
I _{STBY}	Standby Quiescent Current	ent ON/OFF Pin = 0V			100/ 150	μA
I _{CL}	Current Limit		0.8	0.62/ 0.575	1.2/ 1.25	A
IL Output Leakage Current		$V_{IN} = 40V, ON/\overline{OFF}$ Pin = 0V $V_{SWITCH} = 0V$	1		25	μA
		$V_{SWITCH} = -1V, ON/\overline{OFF}$ Pin = 0V	6		15	mA
R _{DS(ON)}	Switch On-Resistance	I _{SWITCH} = 500 mA	0.25		0.40/ 0.60	Ω
f _o	Oscillator Frequency	Measured at Switch Pin	260	225	275	kHz
D	Maximum Duty Cycle		95			%
	Minimum Duty Cycle		0			%
I _{BIAS}	Feedback Bias Current	V _{FEEDBACK} = 1.3V ADJ Version Only	85			nA
$V_{S/D}$	ON/OFF Pin Voltage Thesholds		1.4	0.8	2.0	V
I _{S/D}	ON/OFF Pin Current	ON/OFF Pin = 0V	20	7	37	μA
θ_{JA}	Thermal Resistance	N Package, Junction to Ambient (Note 6)	95			°C/W
		M Package, Junction to Ambient (Note 6)	105			

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but device parameter specifications may not be guaranteed under these conditions. For guaranteed specifications and test conditions, see the Electrical Characteristics.

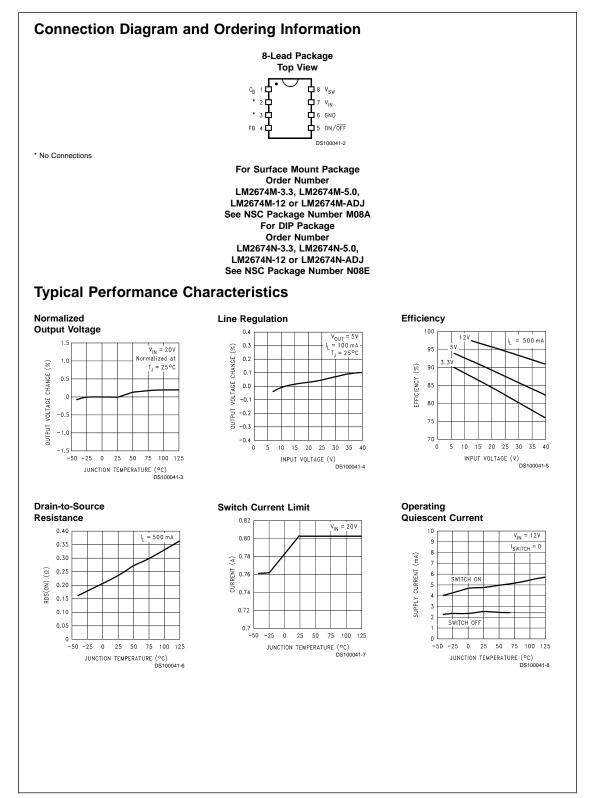
Note 2: The human body model is a 100 pF capacitor discharged through a 1.5 $k\Omega$ resistor into each pin.

Note 3: External components such as the catch diode, inductor, input and output capacitors, and voltage programming resistors can affect switching regulator performance. When the LM2674 is used as shown in *Figures 2, 3* test circuits, system performance will be as specified by the system parameters section of the Electrical Characteristics.

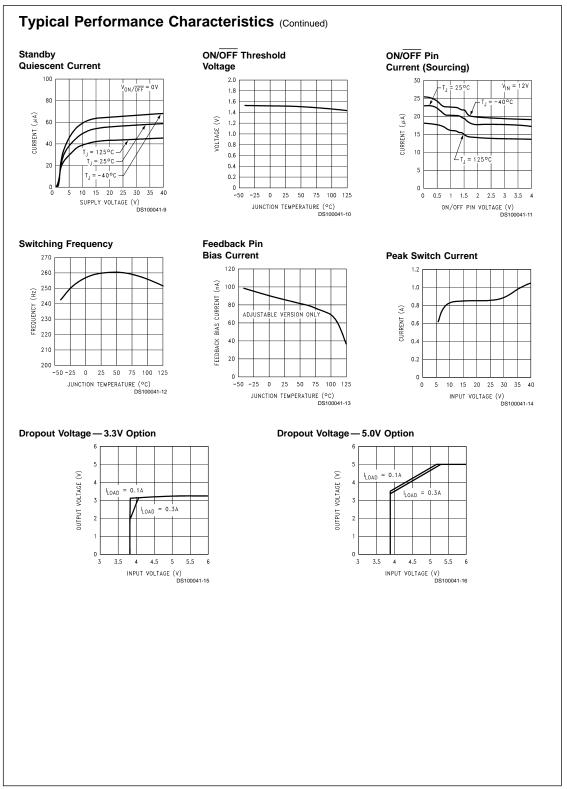
Note 4: Typical numbers are at 25°C and represent the most likely norm.

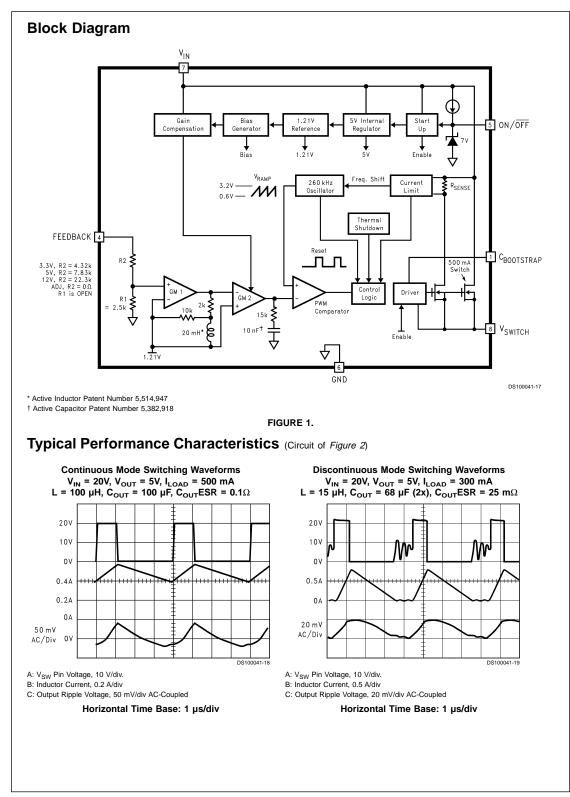
Note 5: All limits guaranteed at room temperature (standard type face) and at temperature extremes (bold type face). All room temperature limits are 100% production tested. All limits at temperature extremes are guaranteed via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).

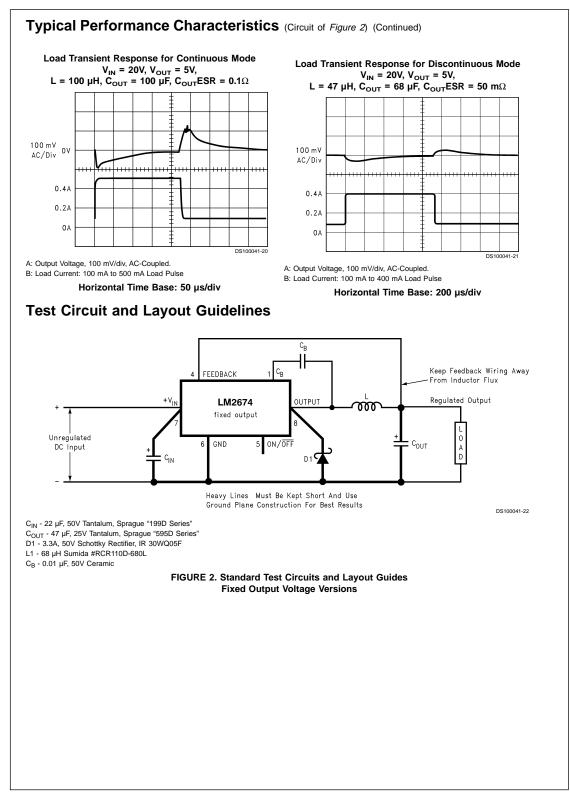
Note 6: Junction to ambient thermal resistance with approximately 1 square inch of printed circuit board copper surrounding the leads. Additional copper area will lower thermal resistance further. See Application Information section in the application note accompanying this datasheet and the thermal model in *LM267X Made Simple* software.

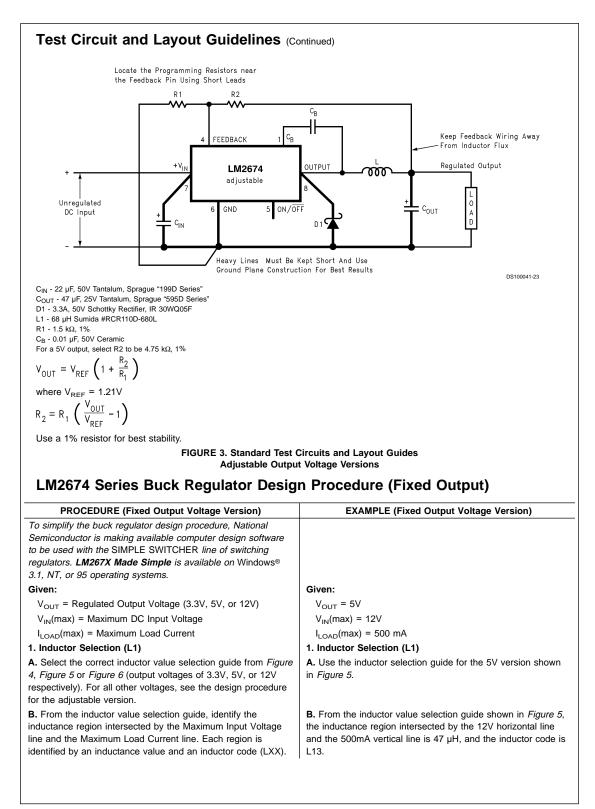


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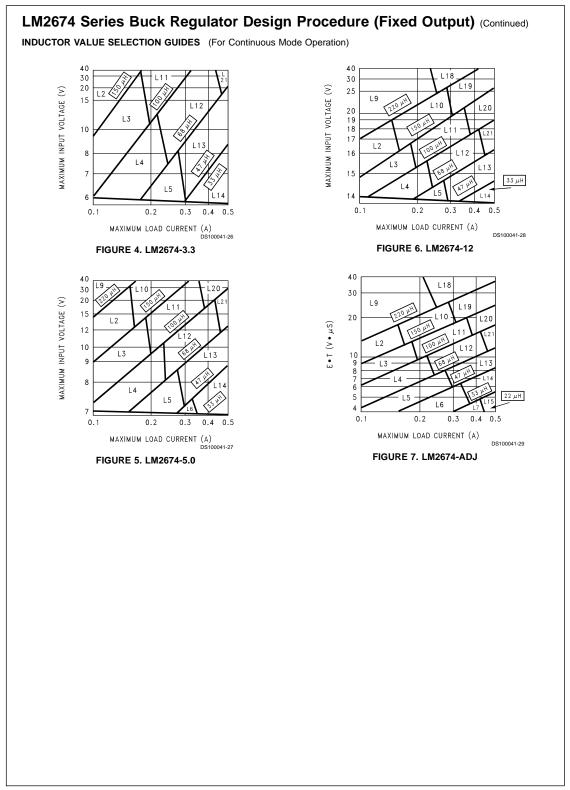






PROCEDURE (Fixed Output Voltage Version)	EXAMPLE (Fixed Output Voltage Version)
C. Select an appropriate inductor from the four manufacturer's part numbers listed in <i>Figure 8</i> . Each manufacturer makes a different style of inductor to allow flexibility in meeting various design requirements. Listed below are some of the differentiating characteristics of each manufacturer's inductors: <i>Schott:</i> ferrite EP core inductors; these have very low leakage magnetic fields to reduce electro-magnetic interference (EMI) and are the lowest power loss inductors	C. The inductance value required is 47 µH. From the table in <i>Figure 8</i> , go to the L13 line and choose an inductor part number from any of the four manufacturers shown. (In most instances, both through hole and surface mount inductors are available.)
<i>Renco:</i> ferrite stick core inductors; benefits are typically lowest cost inductors and can withstand E•T and transient peak currents above rated value. Be aware that these inductors have an external magnetic field which may generate more EMI than other types of inductors.	
Pulse: powered iron toroid core inductors; these can also be low cost and can withstand larger than normal E•T and transient peak currents. Toroid inductors have low EMI.	
<i>Coilcraft:</i> ferrite drum core inductors; these are the smallest physical size inductors, available only as SMT components. Be aware that these inductors also generate EMI—but less than stick inductors.	
Complete specifications for these inductors are available from the respective manufacturers. A table listing the manufacturers' phone numbers is located in <i>Figure 9</i> .	
2. Output Capacitor Selection (C _{OUT})	2. Output Capacitor Selection (C _{OUT})
A. Select an output capacitor from the output capacitor table in <i>Figure 10.</i> Using the output voltage and the inductance value found in the inductor selection guide, step 1, locate the appropriate capacitor value and voltage rating.	A. Use the 5.0V section in the output capacitor table in <i>Figu</i> 10. Choose a capacitor value and voltage rating from the lim that contains the inductance value of 47 μ H. The capacitanc and voltage rating values corresponding to the 47 μ H inductare the:
The capacitor list contains through-hole electrolytic capacitors from four different capacitor manufacturers and surface mount tantalum capacitors from two different capacitor manufacturers. It is recommended that both the manufacturers and the manufacturer's series that are listed in the table be used. A table listing the manufacturers' phone numbers is located in <i>Figure 11</i> .	Surface Mount: 68 μF/10V Sprague 594D Series. 100 μF/10V AVX TPS Series. Through Hole: 68 μF/10V Sanyo OS-CON SA Series. 150 μF/35V Sanyo MV-GX Series. 150 μF/35V Nichicon PL Series. 150 μF/35V Panasonic HFQ Series.
 3. Catch Diode Selection (D1) A. In normal operation, the average current of the catch diode is the load current times the catch diode duty cycle, 1-D (D is the switch duty cycle, which is approximately the output voltage divided by the input voltage). The largest value of the catch diode average current occurs at the maximum load current and maximum input voltage (minimum D). For normal operation, the catch diode current rating must be at least 1.3 times greater than its maximum average current. However, if the power supply design must withstand a continuous output short, the diode should have a current rating equal to the maximum current limit of the LM2674. The most stressful condition. B. The reverse voltage rating of the diode should be at least 	 3. Catch Diode Selection (D1) A. Refer to the table shown in <i>Figure 12</i>. In this example, a 1A, 20V Schottky diode will provide the best performance. If the circuit must withstand a continuous shorted output, a higher current Schottky diode is recommended.
 1.25 times the maximum input voltage. C. Because of their fast switching speed and low forward voltage drop, Schottky diodes provide the best performance and efficiency. This Schottky diode must be located close to the LM2674 using short leads and short printed circuit traces. 	

PROCEDURE (Fixed Output Voltage Version)	EXAMPLE (Fixed Output Voltage Version)
4. Input Capacitor (C _{IN})	4. Input Capacitor (C _{IN})
A low ESR aluminum or tantalum bypass capacitor is needed between the input pin and ground to prevent large voltage transients from appearing at the input. This capacitor should be located close to the IC using short leads. In addition, the RMS current rating of the input capacitor should be selected to be at least ½ the DC load current. The capacitor manufacturer data sheet must be checked to assure that this current rating is not exceeded. The curves shown in <i>Figure 14</i> show typical RMS current ratings for several different aluminum electrolytic capacitor values. A parallel connection of two or more capacitors may be required to increase the total minimum RMS current rating to suit the application requirements. For an aluminum electrolytic capacitor, the voltage rating should be at least 1.25 times the maximum input voltage. Caution must be exercised if solid tantalum capacitors are used. The tantalum capacitor voltage rating should be twice the maximum input voltage. The tables in <i>Figure 15</i> show the recommended application voltage for AVX TPS and Sprague 594D tantalum capacitors. It is also recommended that they be surge current tested by the manufacturer. The TPS series available from AVX, and the 593D and 594D series from Sprague are all surge current stresses on the input capacitor is to add a small inductor in series with the input supply line. Use caution when using ceramic capacitors for input bypassing, because it may cause severe ringing at the V _{IN} pin. 5. Boost Capacitor (C_B) This capacitor develops the necessary voltage to turn the switch gate on fully. All applications should use a 0.01 µF, 50V ceramic capacitor.	The important parameters for the input capacitor are the input voltage rating and the RMS current rating. With a maximum input voltage of 12V, an aluminum electrolytic capacitor with a voltage rating greater than 15V (1.25 x V _{IN}) would be needed. The next higher capacitor voltage rating is 16V. The RMS current rating requirement for the input capacitor in buck regulator is approximately ½ the DC load current. In this example, with a 500mA load, a capacitor with an RMS current rating of at least 250 mA is needed. The curves shown in <i>Figure 14</i> can be used to select an appropriate input capacitor values have RMS current ratings greater than 250 mA. For a through hole design, a 100 μ F/16V electrolytic capacito (Panasonic HFQ series, Nichicon PL, Sanyo MV-GX series o equivalent) would be adequate. Other types or other manufacturers' capacitors can be used provided the RMS ripple current ratings are adequate. Additionally, for a comple surface mount design, electrolytic capacitors such as the Sanyo CV-C or CV-BS and the Nichicon WF or UR and the NIC Components NACZ series could be considered. For surface mount designs, solid tantalum capacitors can be used, but caution must be exercised with regard to the capacitor surge current rating and voltage rating. In this example, checking <i>Figure 15</i> , and the Sprague 594D series datasheet, a Sprague 594D 15 μ F, 25V capacitor is adequate.



Ind.	Induc-	0	Sci	nott	Rene	0	Pulse E	ngineering	Coilcraft
Ref.	tance	Current (A)	Through	Surface	Through	Surface	Through	Surface	Surface
Desg.	(µH)	(~)	Hole	Mount	Hole	Mount	Hole	Mount	Mount
L2	150	0.21	67143920	67144290	RL-5470-4	RL1500-150	PE-53802	PE-53802-S	DO1608-154
L3	100	0.26	67143930	67144300	RL-5470-5	RL1500-100	PE-53803	PE-53803-S	DO1608-104
L4	68	0.32	67143940	67144310	RL-1284-68-43	RL1500-68	PE-53804	PE-53804-S	DO1608-683
L5	47	0.37	67148310	67148420	RL-1284-47-43	RL1500-47	PE-53805	PE-53805-S	DO1608-473
L6	33	0.44	67148320	67148430	RL-1284-33-43	RL1500-33	PE-53806	PE-53806-S	DO1608-333
L7	22	0.52	67148330	67148440	RL-1284-22-43	RL1500-22	PE-53807	PE-53807-S	DO1608-223
L9	220	0.32	67143960	67144330	RL-5470-3	RL1500-220	PE-53809	PE-53809-S	DO3308-224
L10	150	0.39	67143970	67144340	RL-5470-4	RL1500-150	PE-53810	PE-53810-S	DO3308-154
L11	100	0.48	67143980	67144350	RL-5470-5	RL1500-100	PE-53811	PE-53811-S	DO3308-104
L12	68	0.58	67143990	67144360	RL-5470-6	RL1500-68	PE-53812	PE-53812-S	DO3308-683
L13	47	0.70	67144000	67144380	RL-5470-7	RL1500-47	PE-53813	PE-53813-S	DO3308-473
L14	33	0.83	67148340	67148450	RL-1284-33-43	RL1500-33	PE-53814	PE-53814-S	DO3308-333
L15	22	0.99	67148350	67148460	RL-1284-22-43	RL1500-22	PE-53815	PE-53815-S	DO3308-223
L18	220	0.55	67144040	67144420	RL-5471-2	RL1500-220	PE-53818	PE-53818-S	DO3316-224
L19	150	0.66	67144050	67144430	RL-5471-3	RL1500-150	PE-53819	PE-53819-S	DO3316-154
L20	100	0.82	67144060	67144440	RL-5471-4	RL1500-100	PE-53820	PE-53820-S	DO3316-104
L21	68	0.99	67144070	67144450	RL-5471-5	RL1500-68	PE-53821	PE-53821-S	DO3316-683

FIGURE 8. Inductor Manufacturers' Part Numbers

Coilcraft Inc.	Phone	(800) 322-2645
	FAX	(708) 639-1469
Coilcraft Inc., Europe	Phone	+44 1236 730 595
	FAX	+44 1236 730 627
Pulse Engineering Inc.	Phone	(619) 674-8100
	FAX	(619) 674-8262
Pulse Engineering Inc.,	Phone	+353 93 24 107
Europe	FAX	+353 93 24 459
Renco Electronics Inc.	Phone	(800) 645-5828
	FAX	(516) 586-5562
Schott Corp.	Phone	(612) 475-1173
	FAX	(612) 475-1786

FIGURE 9. Inductor Manufacturers' Phone Numbers

www.national.com

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Output Voltage (V)		Output Capacitor								
	Inductance (µH)	Surface Mount								
		Sprague	AVX TPS	Sanyo OS-CON	Sanyo MV-GX	Nichicon	Panasonic			
		594D Series	Series	SA Series	Series	PL Series	HFQ Series			
		(µF/V)	(µF/V)	(µF/V)	(µF/V)	(µF/V)	(µF/V)			
	22	120/6.3	100/10	100/10	330/35	330/35	330/35			
	33	120/6.3	100/10	68/10	220/35	220/35	220/35			
3.3	47	68/10	100/10	68/10	150/35	150/35	150/35			
3.3	68	120/6.3	100/10	100/10	120/35	120/35	120/35			
	100	120/6.3	100/10	100/10	120/35	120/35	120/35			
	150	120/6.3	100/10	100/10	120/35	120/35	120/35			
	22	100/16	100/10	100/10	330/35	330/35	330/35			
	33	68/10	10010	68/10	220/35	220/35	220/35			
5.0	47	68/10	100/10	68/10	150/35	150/35	150/35			
5.0	68	100/16	100/10	100/10	120/35	120/35	120/35			
	100	100/16	100/10	100/10	120/35	120/35	120/35			
	150	100/16	100/10	100/10	120/35	120/35	120/35			
	22	120/20	(2x) 68/20	68/20	330/35	330/35	330/35			
	33	68/25	68/20	68/20	220/35	220/35	220/35			
	47	47/20	68/20	47/20	150/35	150/35	150/35			
12	68	47/20	68/20	47/20	120/35	120/35	120/35			
	100	47/20	68/20	47/20	120/35	120/35	120/35			
	150	47/20	68/20	47/20	120/35	120/35	120/35			
	220	47/20	68/20	47/20	120/35	120/35	120/35			

FIGURE 10. Output Capacitor Table

Nichicon Corp.	Phone	(847) 843-7500
	FAX	(847) 843-2798
Panasonic	Phone	(714) 373-7857
	FAX	(714) 373-7102
AVX Corp.	Phone	(845) 448-9411
	FAX	(845) 448-1943
Sprague/Vishay	Phone	(207) 324-4140
	FAX	(207) 324-7223
Sanyo Corp.	Phone	(619) 661-6322
	FAX	(619) 661-1055

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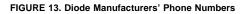
FIGURE 11. Capacitor Manufacturers' Phone Numbers

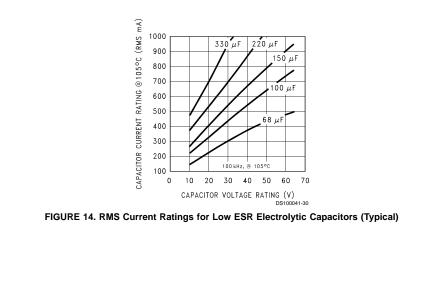
	500mA	Diodes	3A Diodes		
VR	Surface	Through	Surface	Through	
	Mount	Hole	Mount	Hole	
20V	SK12	1N5817	SK32	1N5820	
	B120	SR102		SR302	
30V	SK13	1N5818	SK33	1N5821	
	B130	11DQ03	30WQ03F	31DQ03	
	MBRS130	SR103			
40V	SK14	1N5819	SK34	1N5822	
	B140	11DQ04	30BQ040	MBR340	
	MBRS140	SR104	30WQ04F	31DQ04	
	10BQ040		MBRS340	SR304	
	10MQ040		MBRD340		
	15MQ040				
50V	SK15	MBR150	SK35	MBR350	
	B150	11DQ05	30WQ05F	31DQ05	
	10BQ050	SR105		SR305	

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FIGURE 12. Schottky Diode Selection Table

International Rectifier Corp.	Phone	(310) 322-3331
	FAX	(310) 322-3332
Motorola, Inc.	Phone	(800) 521-6274
	FAX	(602) 244-6609
General Instruments Corp.	Phone	(516) 847-3000
	FAX	(516) 847-3236
Diodes, Inc.	Phone	(805) 446-4800
	FAX	(805) 446-4850





AVX TPS

Recommended	Voltage					
Application Voltage	Rating					
+85°C Rating						
3.3	6.3					
5	10					
10	20					
12	25					
15	35					

Sprague 594D

Recommended	Voltage					
Application Voltage	Rating					
+85°C Rating						
2.5	4					
3.3	6.3					
5	10					
8	16					
12	20					
18	25					
24	35					
29	50					

FIGURE 15. Recommended Application Voltage for AVX TPS and Sprague 594D Tantalum Chip Capacitors Derated for 85°C.

LM2674 Series Buck Regulator Design Procedure (Adjustable Output)

PROCEDURE (Adjustable Output Voltage Version)

EXAMPLE (Adjustable Output Voltage Version)

To simplify the buck regulator design procedure, National Semiconductor is making available computer design software to be used with the SIMPLE SWITCHER line of switching regulators. *LM267X Made Simple* is available for use on Windows 3.1, NT, or 95 operating systems.

Given:

 V_{OUT} = Regulated Output Voltage

V_{IN}(max) = Maximum Input Voltage

I_{LOAD}(max) = Maximum Load Current

F = Switching Frequency (Fixed at a nominal 260 kHz).

1. Programming Output Voltage (Selecting R_1 and $\mathsf{R}_2,$ as shown in Figure 3)

Use the following formula to select the appropriate resistor values.

$$V_{\rm OUT} = V_{\rm REF} \left(1 + \frac{R_2}{R_1} \right)$$

where V_{REF} = 1.21V

Select a value for R₁ between 240 Ω and 1.5 k Ω . The lower resistor values minimize noise pickup in the sensitive feedback pin. (For the lowest temperature coefficient and the best stability with time, use 1% metal film resistors.)

$$R_{2} = R_{1} \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

 $V_{OUT} = 20V$

 $V_{IN}(max) = 28V$

 $I_{LOAD}(max) = 500 mA$

 $\label{eq:F} F = Switching Frequency (Fixed at a nominal 260 kHz).$ **1. Programming Output Voltage** (Selecting R1 and R2, as shown in Figure 3)

Select R_1 to be 1 k Ω , 1%. Solve for R_2 .

$$R_{2} = R_{1} \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) = 1 \text{ k}\Omega \left(\frac{20V}{1.23V} - 1 \right)$$

 R_2 = 1k (16.53 – 1) = 15.53 kΩ, closest 1% value is 15.4 kΩ. R_2 = 15.4 kΩ.

EXAMPLE (Adjustable Output Voltage Version)
2. Inductor Selection (L1)
A. Calculate the inductor Volt • microsecond constant (E • T)
$E \cdot T = (28 - 20 - 0.25) \cdot \frac{20 + 0.5}{28 - 0.25 + 0.5} \cdot \frac{1000}{260} (V \cdot \mu s)$
$E \cdot T = (7.75) \cdot \frac{20.5}{28.25} \cdot 3.85 (V \cdot \mu s) = 21.6 (V \cdot \mu s)$
B. E • T = 21.6 (V • μs)
C. $I_{LOAD}(max) = 500 \text{ mA}$
D. From the inductor value selection guide shown in <i>Figure 7</i> the inductance region intersected by the 21.6 (V $\cdot \mu$ s) horizontal line and the 500mA vertical line is 100 μ H, and the inductor code is L20.
E. From the table in <i>Figure 8</i> , locate line L20, and select an inductor part number from the list of manufacturers part numbers.
3. Output Capacitor Selection (C _{OUT})
A. Use the appropriate row of the capacitor code selection guide, in <i>Figure 16.</i> For this example, use the 15–20V row. The capacitor code corresponding to an inductance of 100 µH is C20.
 B. From the output capacitor selection table in <i>Figure 17</i>, choose a capacitor value (and voltage rating) that intersects the capacitor code(s) selected in section A, C20. The capacitance and voltage rating values corresponding to the capacitor code C20 are the: Surface Mount: 33 μF/25V Sprague 594D Series. 33 μF/25V AVX TPS Series. Through Hole:
 33 μF/25V Sanyo OS-CON SC Series. 120 μF/35V Sanyo MV-GX Series. 120 μF/35V Nichicon PL Series. 120 μF/35V Panasonic HFQ Series.
Other manufacturers or other types of capacitors may also b used, provided the capacitor specifications (especially the 10 kHz ESR) closely match the characteristics of the capacitors

PROCEDURE (Adjustable Output Voltage Version)

4. Catch Diode Selection (D1)

A. In normal operation, the average current of the catch diode is the load current times the catch diode duty cycle, 1-D (D is the switch duty cycle, which is approximately V_{OUT}/V_{IN}). The largest value of the catch diode average current occurs at the maximum input voltage (minimum D). For normal operation, the catch diode current rating must be at least 1.3 times greater than its maximum average current. However, if the power supply design must withstand a continuous output short, the diode should have a current rating greater than the maximum current limit of the LM2674. The most stressful condition for this diode is a shorted output condition.

B. The reverse voltage rating of the diode should be at least 1.25 times the maximum input voltage.

C. Because of their fast switching speed and low forward voltage drop, Schottky diodes provide the best performance and efficiency. The Schottky diode must be located close to the LM2674 using short leads and short printed circuit traces.

5. Input Capacitor (C_{IN})

A low ESR aluminum or tantalum bypass capacitor is needed between the input pin and ground to prevent large voltage transients from appearing at the input. This capacitor should be located close to the IC using short leads. In addition, the RMS current rating of the input capacitor should be selected to be at least 1/2 the DC load current. The capacitor manufacturer data sheet must be checked to assure that this current rating is not exceeded. The curves shown in Figure 14 show typical RMS current ratings for several different aluminum electrolytic capacitor values. A parallel connection of two or more capacitors may be required to increase the total minimum RMS current rating to suit the application requirements. For an aluminum electrolytic capacitor, the voltage rating should be at least 1.25 times the maximum input voltage. Caution must be exercised if solid tantalum capacitors are used. The tantalum capacitor voltage rating should be twice the maximum input voltage. The tables in Figure 15 show the recommended application voltage for AVX TPS and Sprague 594D tantalum capacitors. It is also recommended that they be surge current tested by the manufacturer. The TPS series available from AVX, and the 593D and 594D series from Sprague are all surge current tested. Another approach to minimize the surge current stresses on the input capacitor is to add a small inductor in series with the input supply line. Use caution when using ceramic capacitors for input bypassing, because it may cause severe ringing at the V_{IN} pin.

6. Boost Capacitor (C_B)

This capacitor develops the necessary voltage to turn the switch gate on fully. All applications should use a 0.01 $\mu\text{F},\,50\text{V}$ ceramic capacitor.

EXAMPLE (Adjustable Output Voltage Version)

4. Catch Diode Selection (D1)

A. Refer to the table shown in *Figure 12*. Schottky diodes provide the best performance, and in this example a 500mA, 40V Schottky diode would be a good choice. If the circuit must withstand a continuous shorted output, a higher current (at least 1.2A) Schottky diode is recommended.

5. Input Capacitor (CIN)

The important parameters for the input capacitor are the input voltage rating and the RMS current rating. With a maximum input voltage of 28V, an aluminum electrolytic capacitor with a voltage rating of at least 35V (1.25 x V_{IN}) would be needed. The RMS current rating requirement for the input capacitor in a buck regulator is approximately 1/2 the DC load current. In this example, with a 500mA load, a capacitor with an RMS current rating of at least 250 mA is needed. The curves shown in Figure 14 can be used to select an appropriate input capacitor. From the curves, locate the 35V line and note which capacitor values have RMS current ratings greater than 250 mA. For a through hole design, a 68 µF/35V electrolytic capacitor (Panasonic HFQ series, Nichicon PL, Sanyo MV-GX series or equivalent) would be adequate. Other types or other manufacturers' capacitors can be used provided the RMS ripple current ratings are adequate. Additionally, for a complete surface mount design, electrolytic capacitors such as the Sanyo CV-C or CV-BS, and the Nichicon WF or UR and the NIC Components NACZ series could be considered. For surface mount designs, solid tantalum capacitors can be used, but caution must be exercised with regard to the capacitor surge current rating and voltage rating. In this example, checking Figure 15, and the Sprague 594D series datasheet, a Sprague 594D 15 µF, 50V capacitor is adequate.

6. Boost Capacitor (C_B)

For this application, and all applications, use a 0.01 $\mu\text{F},\,50\text{V}$ ceramic capacitor.

Case	Output	Inductance (µH)							
Style (Note 7)	Voltage (V)	22	33	47	68	100	150	220	
SM and TH	1.21-2.50	_	_	_	-	C1	C2	C3	
SM and TH	2.50-3.75	_	_	_	C1	C2	C3	C3	
SM and TH	3.75-5.0	—	_	C4	C5	C6	C6	C6	
SM and TH	5.0-6.25	—	C4	C7	C6	C6	C6	C6	
SM and TH	6.25-7.5	C8	C4	C7	C6	C6	C6	C6	
SM and TH	7.5–10.0	C9	C10	C11	C12	C13	C13	C13	
SM and TH	10.0-12.5	C14	C11	C12	C12	C13	C13	C13	
SM and TH	12.5-15.0	C15	C16	C17	C17	C17	C17	C17	
SM and TH	15.0-20.0	C18	C19	C20	C20	C20	C20	C20	
SM and TH	20.0-30.0	C21	C22	C22	C22	C22	C22	C22	
TH	30.0-37.0	C23	C24	C24	C25	C25	C25	C25	

Note 7: SM - Surface Mount, TH - Through Hole

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FIGURE 16. Capacitor Code Selection Guide

Output Capacitor										
Cap. Ref.	Surface	Mount	Through Hole							
	Sprague	AVX TPS	Sanyo OS-CON	Sanyo MV-GX	Nichicon	Panasonic				
Desg.	594D Series	Series	SA Series	Series	PL Series	HFQ Series				
#	(µF/V)	(µF/V)	(µF/V)	(µF/V)	(µF/V)	(µF/V)				
C1	120/6.3	100/10	100/10	220/35	220/35	220/35				
C2	120/6.3	100/10	100/10	150/35	150/35	150/35				
C3	120/6.3	100/10	100/35	120/35	120/35	120/35				
C4	68/10	100/10	68/10	220/35	220/35	220/35				
C5	100/16	100/10	100/10	150/35	150/35	150/35				
C6	100/16	100/10	100/10	120/35	120/35	120/35				
C7	68/10	100/10	68/10	150/35	150/35	150/35				
C8	100/16	100/10	100/10	330/35	330/35	330/35				
C9	100/16	100/16	100/16	330/35	330/35	330/35				
C10	100/16	100/16	68/16	220/35	220/35	220/35				
C11	100/16	100/16	68/16	150/35	150/35	150/35				
C12	100/16	100/16	68/16	120/35	120/35	120/35				
C13	100/16	100/16	100/16	120/35	120/35	120/35				
C14	100/16	100/16	100/16	220/35	220/35	220/35				
C15	47/20	68/20	47/20	220/35	220/35	220/35				
C16	47/20	68/20	47/20	150/35	150/35	150/35				
C17	47/20	68/20	47/20	120/35	120/35	120/35				
C18	68/25	(2x) 33/25	47/25 (Note 8)	220/35	220/35	220/35				
C19	33/25	33/25	33/25 (Note 8)	150/35	150/35	150/35				
C20	33/25	33/25	33/25 (Note 8)	120/35	120/35	120/35				
C21	33/35	(2x) 22/25	(Note 9)	150/35	150/35	150/35				
C22	33/35	22/35	(Note 9)	120/35	120/35	120/35				
C23	(Note 9)	(Note 9)	(Note 9)	220/50	100/50	120/50				
C24	(Note 9)	(Note 9)	(Note 9)	150/50	100/50	120/50				
C25	(Note 9)	(Note 9)	(Note 9)	150/50	82/50	82/50				

Note 8: The SC series of Os-Con capacitors (others are SA series)

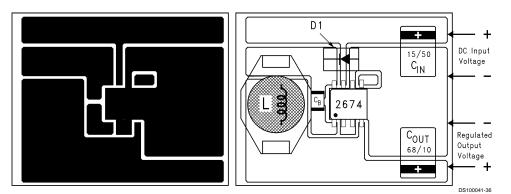
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Note 9: The voltage ratings of the surface mount tantalum chip and Os-Con capacitors are too low to work at these voltages.

FIGURE 17. Output Capacitor Selection Table

Application Information

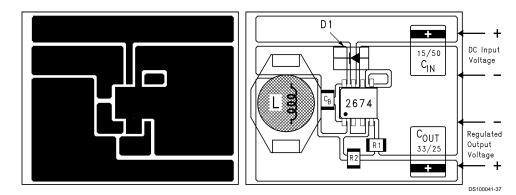
TYPICAL SURFACE MOUNT PC BOARD LAYOUT, FIXED OUTPUT (4X SIZE)



 $\begin{array}{l} C_{IN} : 15 \ \mu\text{F}, 25\text{V}, \text{Solid Tantalum Sprague, "594D series"} \\ C_{OUT} : 68 \ \mu\text{F}, 10\text{V}, \text{Solid Tantalum Sprague, "594D series"} \\ D1 : 1A, 40\text{V Schottky Rectifier, Surface Mount} \end{array}$

L1 - 47 µH, L13, Coilcraft DO3308 C_B - 0.01 µF, 50V, Ceramic

TYPICAL SURFACE MOUNT PC BOARD LAYOUT, ADJUSTABLE OUTPUT (4X SIZE)



 $\begin{array}{l} C_{IN} \mbox{-} 15\ \mu\text{F},\ 50\text{V},\ Solid\ Tantalum\ Sprague,\ "594D\ series"}\\ C_{OUT} \mbox{-} 33\ \mu\text{F},\ 25\text{V},\ Solid\ Tantalum\ Sprague,\ "594D\ series"}\\ D1 \mbox{-} 14,\ 40\text{V\ Schottky\ Rectifier,\ Surface\ Mount}\\ L1 \mbox{-} 100\ \mu\text{H},\ L20,\ Colicraft\ DO316 \end{array}$

C_B - 0.01 µF, 50V, Ceramic

R1 - 1k, 1%

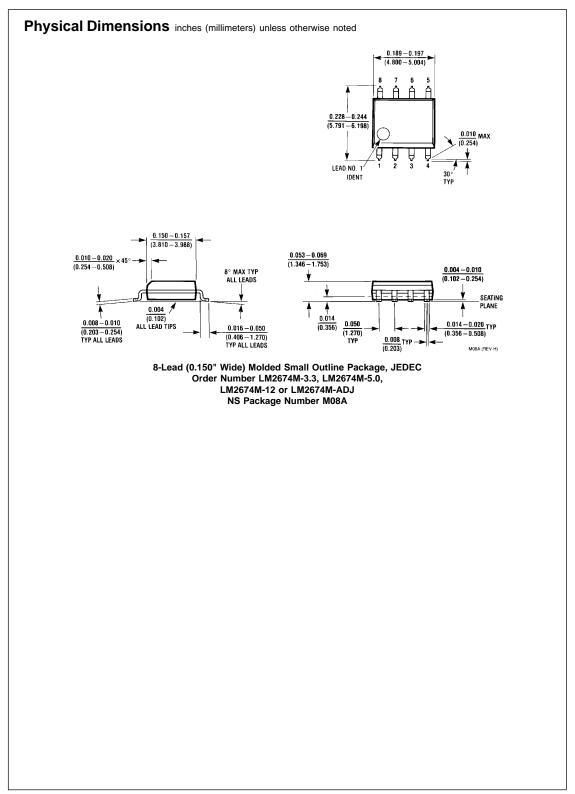
R2 - Use formula in Design Procedure

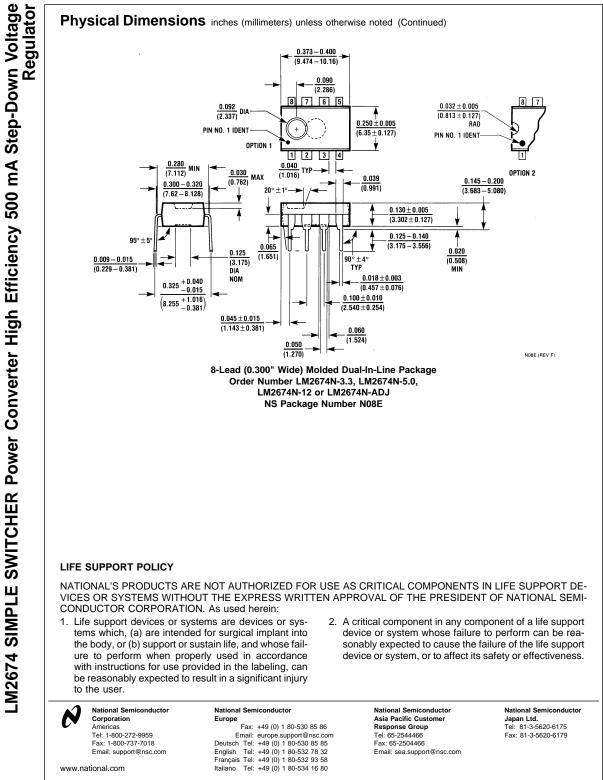
FIGURE 18. PC Board Layout

Layout is very important in switching regulator designs. Rapidly switching currents associated with wiring inductance can generate voltage transients which can cause problems. For minimal inductance and ground loops, the wires indicated by heavy lines (in *Figure 2* and *Figure 3*) should be wide printed circuit traces and should be kept as short as possible. For best results, external components should be located as close to the switcher IC as possible using ground plane construction or single point grounding.

If **open core inductors are used**, special care must be taken as to the location and positioning of this type of inductor. Allowing the inductor flux to intersect sensitive feedback, IC ground path, and C_{OUT} wiring can cause problems.

When using the adjustable version, special care must be taken as to the location of the feedback resistors and the associated wiring. Physically locate both resistors near the IC, and route the wiring away from the inductor, especially an open core type of inductor.





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